

### Electrical Features

- Trench/Fieldstop IGBT
- $V_{CEsat}$  with positive Temperature Coefficient
- Low  $V_{CEsat}$

### Typical Applications

- Motor Drives
- Servo Drives
- Auxiliary Inverters



### Mechanical Features

- High power density
- Integrated NTC temperature sensor
- Copper base plate
- Solder contact technology
- Standard housing

### IGBT ,Inverter

Maximum Rated Values						
Symbol	Item	Conditions	Rating			Unit
IGBT						
$V_{CES}$	Collector- emitter voltage	$T_{vj}=25^{\circ}C$	1200			V
$V_{GES}$	Gate-emitter voltage	-	$\pm 20$			V
$I_C$	Collector current,DC	$T_C=80^{\circ}C, T_{vj}=175^{\circ}C$	40			A
$I_{CRM}$	Repetitive peak collector current	$t_p=1ms$	80			A
$P_{tot}$	Total power dissipation	$T_C=25^{\circ}C, T_{vj}=175^{\circ}C$	250			W
Characteristics Values						
Symbol	Item	Conditions	Values			Unit
IGBT			Min.	Typ.	Max.	
$I_{CES}$	Collector-emitter cut-off current	$V_{CE}=1200V, V_{GE}=0V, T_{vj}=25^{\circ}C$	-	-	1	mA
$I_{GES}$	Gate leakage current	$V_{CE}=0V, V_{GE}=20V, T_{vj}=25^{\circ}C$	-	-	100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=1.5mA, V_{CE}=V_{GE}, T_{vj}=25^{\circ}C$	5.2	5.6	6.6	V
$V_{CEsat}$	Collector-emitter saturation voltage	$I_C=40A$ $V_{GE}=15V$ $T_{vj}=25^{\circ}C$	-	2.23	-	
		$T_{vj}=125^{\circ}C$	-	2.52	-	
		$T_{vj}=150^{\circ}C$	-	2.69	-	
$C_{ies}$	Input capacitance	$V_{CE}=25V, V_{GE}=0V$ $f=1MHz, T_{vj}=25^{\circ}C$	-	1.77	-	nF
$C_{oes}$	Output capacitance		-	0.17	-	
$C_{res}$	Reverse transfer capacitance		-	0.06	-	
$Q_G$	Gate charge	$V_{CC}=600V, I_C=40A$ $V_{GE}=-15...+15V, T_{vj}=25^{\circ}C$	-	0.171	-	$\mu C$
$R_g$	Internal gate resistance	$T_{vj}=25^{\circ}C$	-	-	-	$\Omega$

$t_{d(on)}$	Turn-on delay time	$V_{CC}=600V$ $I_C=40A$ $V_{GE}=\pm 15V$ $R_{G(on)}=51\Omega$ $R_{G(off)}=51\Omega$	$T_{vj}=25^\circ C$	-	200.1	-	ns
			$T_{vj}=125^\circ C$	-	170.4	-	
			$T_{vj}=150^\circ C$	-	160.4	-	
$t_r$	Rise time		$T_{vj}=25^\circ C$	-	94.6	-	
			$T_{vj}=125^\circ C$	-	87.6	-	
			$T_{vj}=150^\circ C$	-	83.6	-	
$t_{d(off)}$	Turn-off delay time		$T_{vj}=25^\circ C$	-	480.5	-	
			$T_{vj}=125^\circ C$	-	512.0	-	
			$T_{vj}=150^\circ C$	-	524.8	-	
$t_f$	Fall time		$T_{vj}=25^\circ C$	-	209.0	-	
			$T_{vj}=125^\circ C$	-	330.8	-	
			$T_{vj}=150^\circ C$	-	340.0	-	
$E_{on}$	Turn-on energy (per pulse)	$V_{CC}=600V, I_C=40A$ $V_{GE}=\pm 15V, R_{G(on)}=51\Omega$ $di/dt=890A/\mu s(T_{vj}=150^\circ C)$	$T_{vj}=25^\circ C$	-	11.14	-	mJ
			$T_{vj}=125^\circ C$	-	12.81	-	
			$T_{vj}=150^\circ C$	-	13.37	-	
$E_{off}$	Turn-off energy (per pulse)		$T_{vj}=25^\circ C$	-	2.59	-	
			$T_{vj}=125^\circ C$	-	3.36	-	
			$T_{vj}=150^\circ C$	-	3.52	-	
SC data	Short-circuit current	$V_{CC}=600V, V_{GE}\leq 15V, T_{vj}=125^\circ C$ $V_{CES}\leq 1200V, t_p\leq 10\mu s$	-	180	-	A	
$R_{thJC}$	Thermal resistance, junction to case	Per IGBT	-	-	0.6	K/W	
$R_{thCH}$	Thermal resistance, case to heatsink	Per IGBT $\lambda_{grease}=1W/(m\cdot K)$	-	-	-	K/W	
$T_{vjop}$	Temperature under switching conditions		-40		150	$^\circ C$	
<b>Diode , Inverter</b>							
<b>Maximum Rated Values</b>							
Symbol	Item	Conditions		Rating		Unit	
$V_{RRM}$	Repetitive peak reverse voltage	$T_{vj}=25^\circ C$		1200		V	
$I_F$	Forward current, DC	$T_C=80^\circ C, T_{vj}=175^\circ C$		40		A	
$I_{FRM}$	Repetitive peak forward current	$t_p=1ms$		80		A	
$I^2t$	$I^2t$ -value	$V_R=0V, t_p=10ms, T_{vj}=125^\circ C$		320		$A^2s$	
<b>Characteristic Values</b>			Min.	Typ.	Max.		
$V_F$	Continuous forward voltage	$I_F=40A$ $V_{GE}=0V$	$T_{vj}=25^\circ C$	-	2.41	-	V
			$T_{vj}=125^\circ C$	-	2.11	-	
			$T_{vj}=150^\circ C$	-	2.04	-	
$I_{RM}$	Peak reverse recovery current		$T_{vj}=25^\circ C$	-	15.3	-	A
			$T_{vj}=125^\circ C$	-	20.9	-	
			$T_{vj}=150^\circ C$	-	22.9	-	
$t_{rr}$	Reverse recovery time	$I_F=40A$ $V_{GE}=-15V$ $-di_F/dt=650A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj}=25^\circ C$	-	90.9	-	ns
			$T_{vj}=125^\circ C$	-	246.0	-	
			$T_{vj}=150^\circ C$	-	644.4	-	
$Q_r$	Recovered charge		$T_{vj}=25^\circ C$	-	1.87	-	$\mu C$
			$T_{vj}=125^\circ C$	-	6.30	-	
			$T_{vj}=150^\circ C$	-	7.34	-	

E <sub>rec</sub>	Reverse recovery energy		T <sub>vj</sub> =25°C	-	0.82	-	mJ
			T <sub>vj</sub> =125°C	-	2.01	-	
			T <sub>vj</sub> =150°C	-	2.27	-	
R <sub>thJC</sub>	Thermal resistance, junction to case	per diode	-	-	0.95	-	K/W
R <sub>thCH</sub>	Thermal resistance, case to heatsink	Per diode, λ <sub>grease</sub> =1 W/(m·K)	-	-	-	-	K/W
T <sub>vjop</sub>	Temperature under switching conditions		-40		150		°C

**Diode, Rectifier**
**Maximum Rated Values**

Symbol	Item	Conditions	Rating	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	T <sub>vj</sub> =25°C	1800	V
I <sub>FRMSM</sub>	Maximum RMS forward current per chip	T <sub>C</sub> =80°C	50	A
I <sub>RMSM</sub>	Maximum RMS current at rectifier output	T <sub>C</sub> =80°C	60	A
I <sub>FSM</sub>	Surge forward current	t <sub>p</sub> = 10 ms, T <sub>vj</sub> = 150°C	350	A
I <sup>2</sup> t	I <sup>2</sup> t-value	t <sub>p</sub> = 10ms, T <sub>vj</sub> = 150°C	605	A <sup>2</sup> s

**Characteristic Values**

Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
V <sub>F</sub>	Continuous forward voltage	I <sub>F</sub> =40A V <sub>GE</sub> =0V	T <sub>vj</sub> =25°C	-	1.36	-	V
			T <sub>vj</sub> =125°C	-	1.25	-	
			T <sub>vj</sub> =150°C	-	1.17	-	
I <sub>R</sub>	Reverse current	V <sub>R</sub> =1800V	T <sub>vj</sub> =25°C	-	-	10	uA
			T <sub>vj</sub> =125°C	-	-	-	
			T <sub>vj</sub> =150°C	-	-	-	
T <sub>vjop</sub>	Temperature under switching conditions		-40		150	°C	

**IGBT, Brake-Chopper**

Maximum Rated Values				
Symbol	Item	Conditions	Values	Unit
V <sub>CES</sub>	Collector-emitter voltage	T <sub>vj</sub> =25°C	1200	V
V <sub>GES</sub>	Gate-emitter voltage	-	±20	V
I <sub>C</sub>	Collector current, DC	T <sub>C</sub> =100°C, T <sub>vj</sub> =175°C	15	A
I <sub>CRM</sub>	Repetitive peak collector current	t <sub>p</sub> =1ms	30	A
P <sub>tot</sub>	Total power dissipation	T <sub>C</sub> =25°C, T <sub>vj</sub> =175°C	125	W

**Characteristic Values**

Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
IGBT							
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V, T <sub>vj</sub> =25°C	-	-	1	mA	
I <sub>GES</sub>	Gate leakage current	V <sub>CE</sub> =0V, V <sub>GE</sub> =20V, T <sub>vj</sub> =25°C	-	-	100	nA	
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	I <sub>C</sub> =0.5mA, V <sub>CE</sub> =V <sub>GE</sub> , T <sub>vj</sub> =25°C	5.7	6.2	6.7	V	
V <sub>CEsat</sub>	Collector-emitter saturation voltage	I <sub>C</sub> =15A V <sub>GE</sub> =15V	T <sub>vj</sub> =25°C	-	1.89		-
			T <sub>vj</sub> =125°C	-	2.25		-
			T <sub>vj</sub> =150°C	-	2.32	-	

$C_{ies}$	Input capacitance	$V_{CE}=25V, V_{GE}=0V$ $f=1MHz, T_{vj}=25^{\circ}C$	-	1.19	-	nF	
$C_{oes}$	Output capacitance		-	0.08	-		
$C_{res}$	Reverse transfer capacitance		-	0.04	-		
$Q_G$	Gate charge	$V_{CC}=600V, I_C=15A$ $V_{GE}=-15...+15V, T_{vj}=25^{\circ}C$	-	0.094	-	$\mu C$	
$R_g$	Internal gate resistance	$T_{vj}=25^{\circ}C$	-	-	-	$\Omega$	
$t_{d(on)}$	Turn-on delay time	$V_{CC}=600V$ $I_C=15A$ $V_{GE}=\pm 15V$ $R_{G(on)}=51\Omega$ $R_{G(off)}=51\Omega$	$T_{vj}=25^{\circ}C$	-	270.2	-	ns
			$T_{vj}=125^{\circ}C$	-	143.5	-	
			$T_{vj}=150^{\circ}C$	-	133.9	-	
$t_r$	Rise time		$T_{vj}=25^{\circ}C$	-	204.1	-	
			$T_{vj}=125^{\circ}C$	-	111.1	-	
			$T_{vj}=150^{\circ}C$	-	99.2	-	
$t_{d(off)}$	Turn-off delay time		$T_{vj}=25^{\circ}C$	-	198.4	-	
			$T_{vj}=125^{\circ}C$	-	153.8	-	
			$T_{vj}=150^{\circ}C$	-	131.2	-	
$t_f$	Fall time		$T_{vj}=25^{\circ}C$	-	298.4	-	
			$T_{vj}=125^{\circ}C$	-	165.3	-	
			$T_{vj}=150^{\circ}C$	-	132.1	-	
$E_{on}$	Turn-on energy (per pulse)	$T_{vj}=25^{\circ}C$	-	3.3	-	mJ	
		$T_{vj}=125^{\circ}C$	-	3.8	-		
		$T_{vj}=150^{\circ}C$	-	3.9	-		
$E_{off}$	Turn-off energy (per pulse)	$T_{vj}=25^{\circ}C$	-	0.94	-		
		$T_{vj}=125^{\circ}C$	-	1.22	-		
		$T_{vj}=150^{\circ}C$	-	1.29	-		
SC data	Short-circuit current	$V_{CC}=600V, V_{GE}\leq 15V, T_{vj}=125^{\circ}C$ $V_{CES}\leq 1200V, t_p\leq 10\mu s$	-	60	-	A	
$R_{thJC}$	Thermal resistance, junction to case	Per IGBT	-	-	1.2	K/W	
$R_{thCH}$	Thermal resistance, case to heatsink	Per IGBT $\lambda_{grease}=1W/(m\cdot K)$	-	-	-	K/W	
$T_{vjop}$	Temperature under switching conditions		-40		150	$^{\circ}C$	
<b>Diode , Brake- Chopper</b>							
<b>Maximum Rated Values</b>							
Symbol	Item	Conditions		Rating		Unit	
$V_{RRM}$	Repetitive peak reverse voltage	$T_{vj}=25^{\circ}C$		1200		V	
$I_F$	Forward current, DC	$T_C=80^{\circ}C, T_{vj}=175^{\circ}C$		10		A	
$I_{FRM}$	Repetitive peak forward current	$t_p=1ms$		20		A	
$I^2t$	$I^2t$ -value	$V_R=0V, t_p=10ms, T_{vj}=125^{\circ}C$		20		$A^2s$	
<b>Characteristic Values</b>				Min.	Typ.	Max.	
$V_F$	Continuous forward voltage	$I_F=10A$ $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	-	2.35	-	V
			$T_{vj}=125^{\circ}C$	-	2.06	-	
			$T_{vj}=150^{\circ}C$	-	2.02	-	

I <sub>RM</sub>	Peak reverse recovery current	V <sub>R</sub> =600V I <sub>F</sub> = 10A V <sub>GE</sub> =- 15V -di <sub>F</sub> /dt=600A/μs (T <sub>vj</sub> = 150°C)	T <sub>vj</sub> =25°C	-	9.7	-	A
			T <sub>vj</sub> = 125°C	-	8.6	-	
			T <sub>vj</sub> = 150°C	-	8.4	-	
t <sub>rr</sub>	Reverse recovery time		T <sub>vj</sub> =25°C	-	1054	-	ns
			T <sub>vj</sub> = 125°C	-	969.7	-	
			T <sub>vj</sub> = 150°C	-	943.1	-	
Q <sub>r</sub>	Recovered charge		T <sub>vj</sub> =25°C	-	3.2	-	μC
			T <sub>vj</sub> = 125°C	-	3.5	-	
			T <sub>vj</sub> = 150°C	-	3.8	-	
E <sub>rec</sub>	Reverse recovery energy	T <sub>vj</sub> =25°C	-	0.88	-	mJ	
		T <sub>vj</sub> = 125°C	-	1.41	-		
		T <sub>vj</sub> = 150°C	-	1.46	-		
R <sub>thJC</sub>	Thermal resistance, junction to case	per diode	-	-	2.3	K/W	
R <sub>thCH</sub>	Thermal resistance, case to heatsink	per diode , λ <sub>grease</sub> = 1 W/(m • K)	-	-	-	K/W	
T <sub>vjop</sub>	Temperature under switching conditions		-40		150	°C	

Note:

IGBT electrical characteristics according to IEC 60747 – 9

Diode electrical characteristics according to IEC 60747 – 2

### Module

Symbol	Item	Conditions	Rating			Unit
V <sub>ISOL</sub>	Isolation voltage	Terminals to baseplate, RMS,f=50Hz,t=1min	2500			V
T <sub>vjmax</sub>	Maximum junction temperature	-	175			°C
T <sub>vjop</sub>	Operating junction temperature	Continuous operationg(under switching)	-40~ 150			°C
T <sub>stg</sub>	Storage temperature	-	-40~ 125			°C
Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
M <sub>s</sub>	Mounting torque	Mounting to heat sink,M5 screw	3	-	6	Nm
d <sub>s</sub>	Creepage distance	Terminal to terminal	-	-	-	mm
		Terminal to base plate	-	10	-	
d <sub>a</sub>	Clearance	Terminal to terminal	-	-	-	mm
		Terminal to base plate	-	7.5	-	
m	Weight	-	-	180	-	g

### NTC Thermistor Characteristics

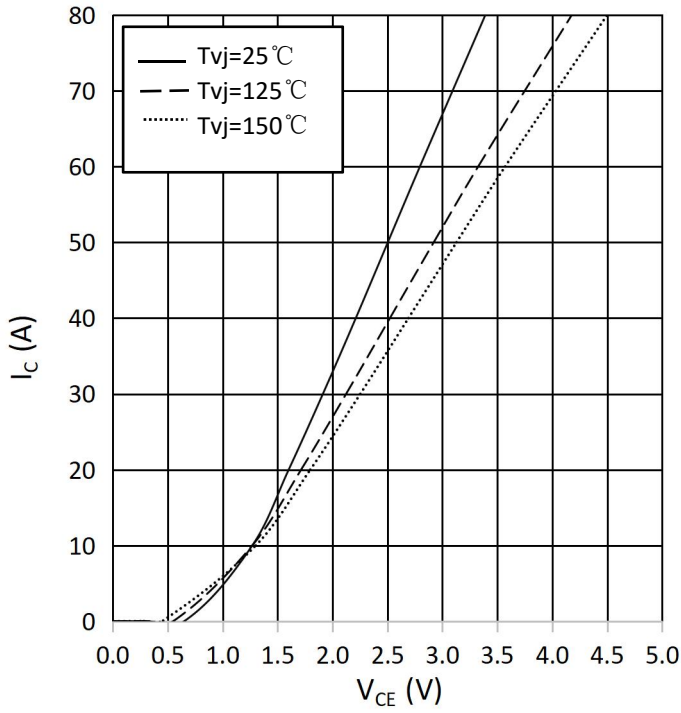
Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
R <sub>25</sub>	Rated resistance	T <sub>C</sub> =25°C	-	5	-	kΩ
ΔR/R	Deviation of resistance	T <sub>C</sub> = 100°C ,R <sub>100</sub> =493Ω	-5	-	5	%
P <sub>25</sub>	Power dissipation	T <sub>C</sub> =25°C	-	-	20	mW

B <sub>25/100</sub>	B-constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/100</sub> ( 1/T <sub>2</sub> - 1/(298. 15K))]	-	3433	-	K
B <sub>25/50</sub>	B- constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/50</sub> ( 1/T <sub>2</sub> - 1/(298. 15K))]	-	3375	-	
B <sub>25/80</sub>	B- constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/80</sub> ( 1/T <sub>2</sub> - 1/(298. 15K))]	-	3411	-	

**output characteristic IGBT, Inverter (typical)**

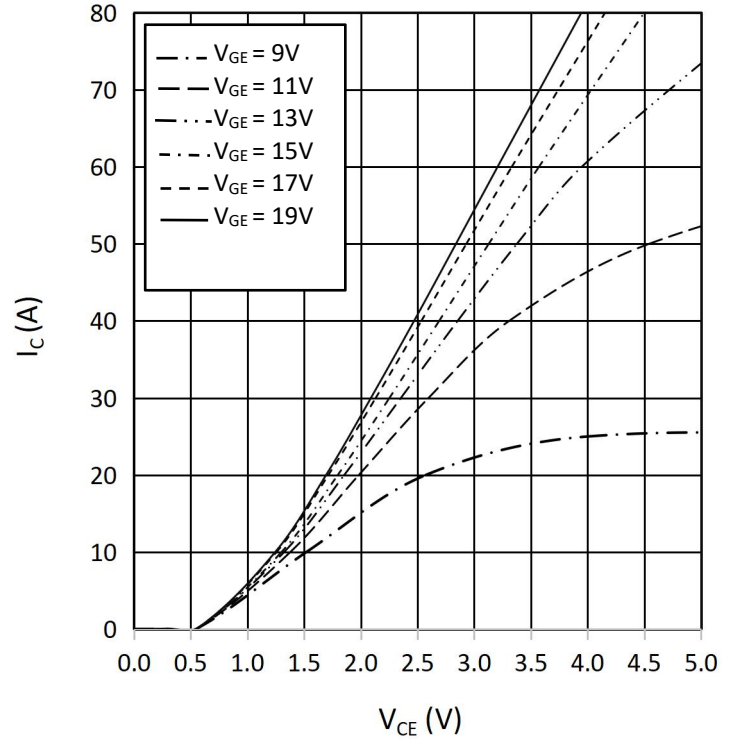
$I_C = f(V_{CE})$

$V_{GE} = 15V$


**output characteristic IGBT, Inverter (typical)**

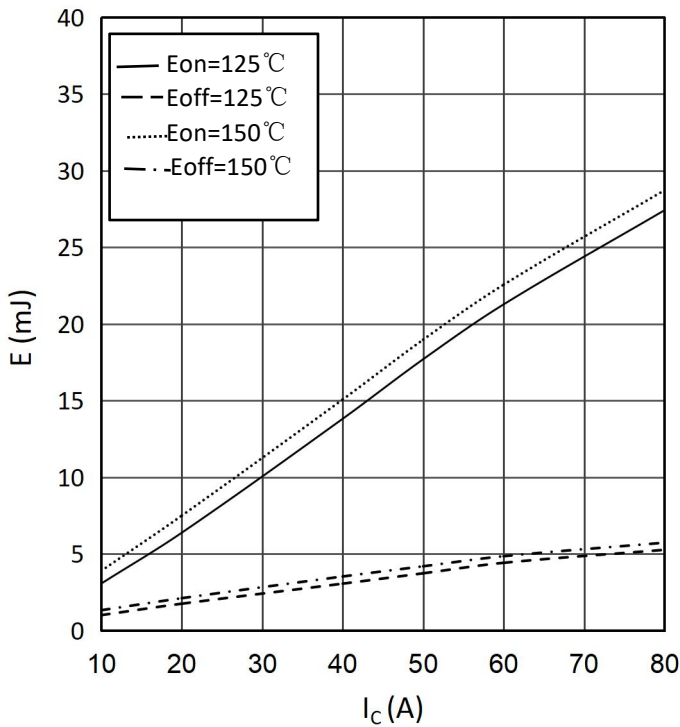
$I_C = f(V_{CE})$

$T_{vj} = 150^\circ C$


**switching losses IGBT, Inverter (typical)**

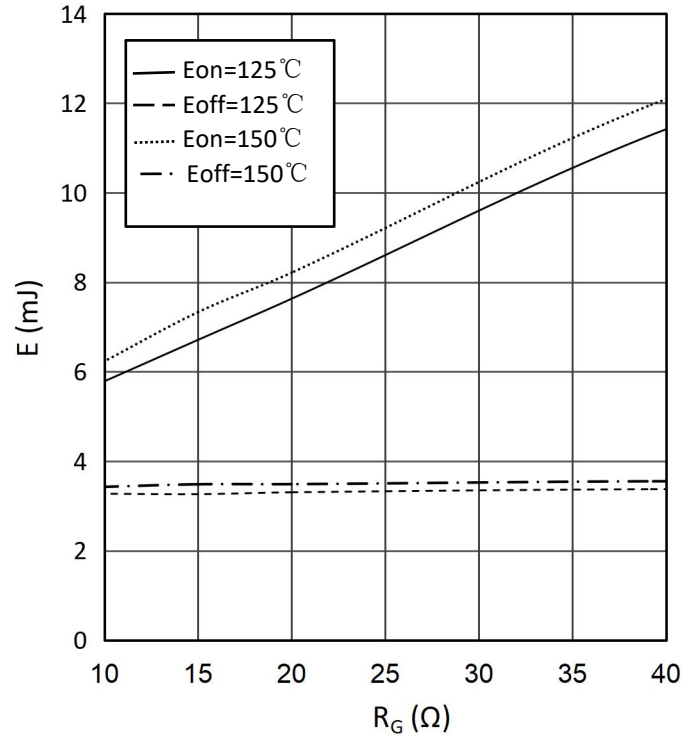
$E_{on} = f(I_C), E_{off} = f(I_C)$

$V_{GE} = \pm 15V, R_{Gon} = 51\Omega, R_{Goff} = 51\Omega, V_{CE} = 600V$


**switching losses IGBT, Inverter (typical)**

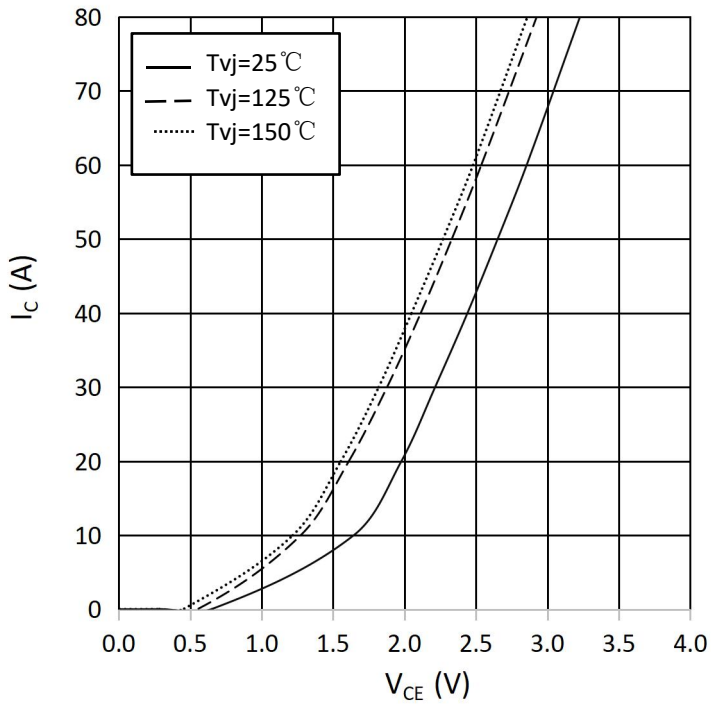
$E_{on} = f(R_G), E_{off} = f(R_G)$

$V_{GE} = \pm 15V, I_C = 40A, V_{CE} = 600V$



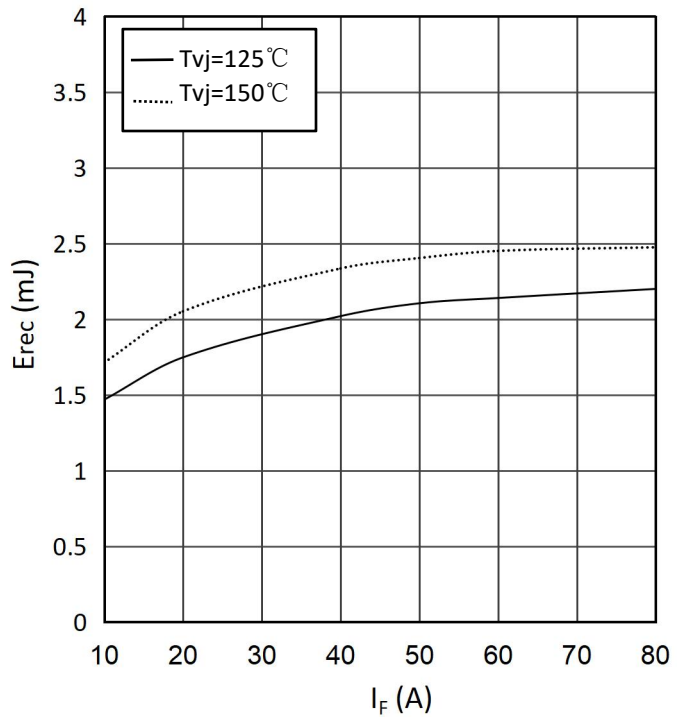
**forward characteristic of Diode, Inverter (typical)**

$$I_F = f(V_F)$$


**switching losses Diode, Inverter (typical)**

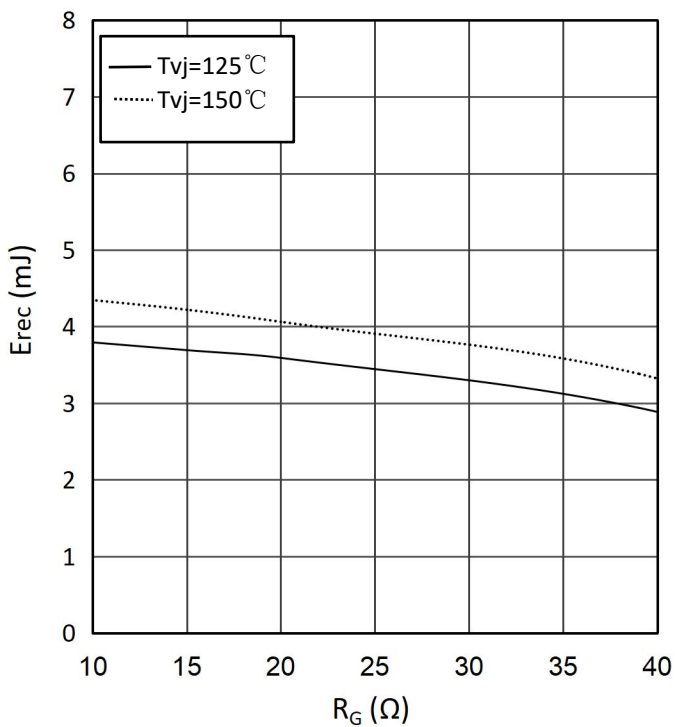
$$E_{rec} = f(I_F)$$

$$R_{Gon} = 51\Omega, V_{CE} = 600V$$


**switching losses Diode, Inverter (typical)**

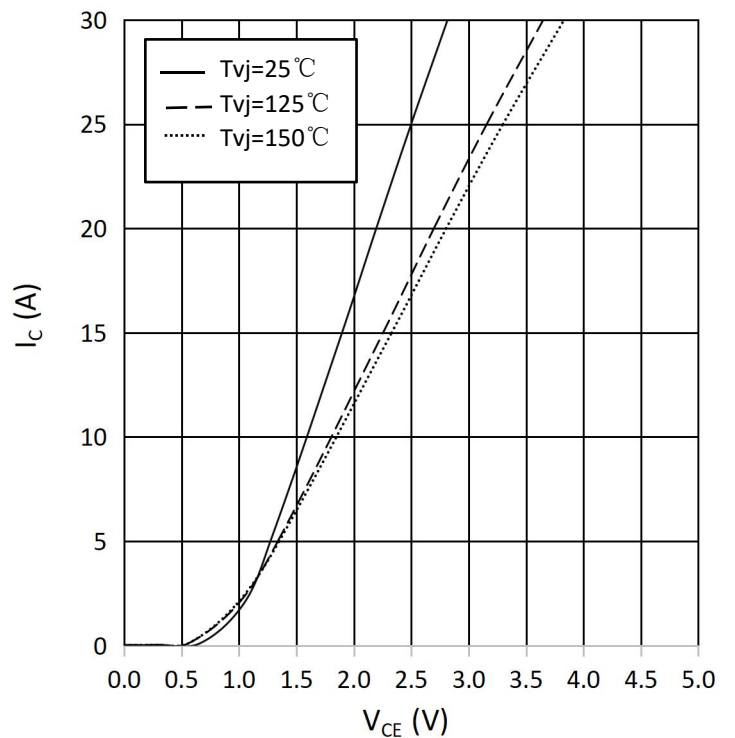
$$E_{rec} = f(R_G)$$

$$I_F = 40A, V_{CE} = 600V$$


**output characteristic IGBT, Brake-Chopper (typical)**

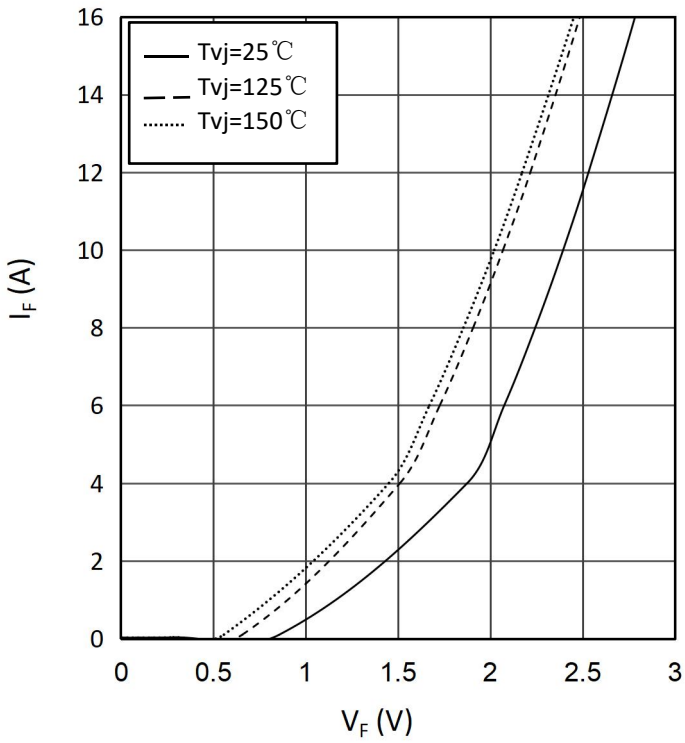
$$I_C = f(V_{CE})$$

$$V_{GE} = 15V$$



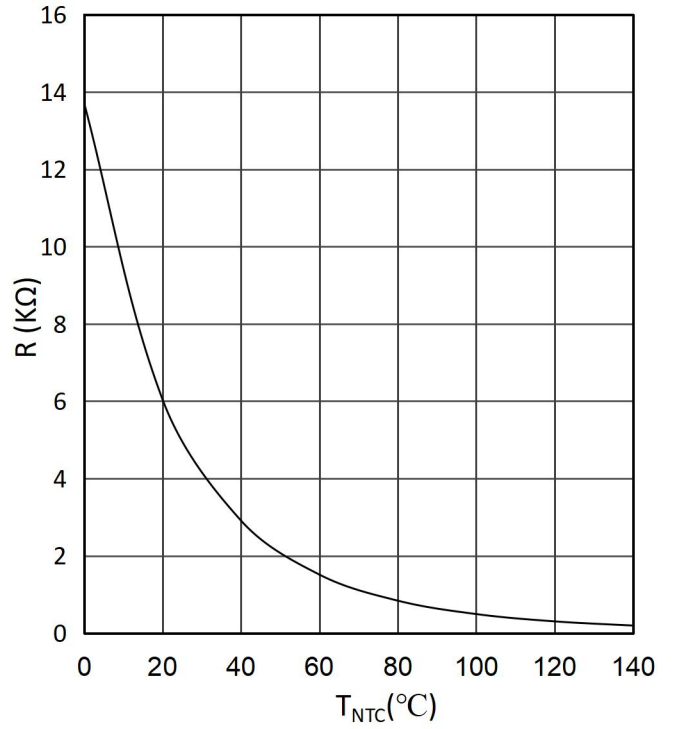
**forward characteristic of Diode, Brake-Chopper (typical)**

$I_F = f(V_F)$



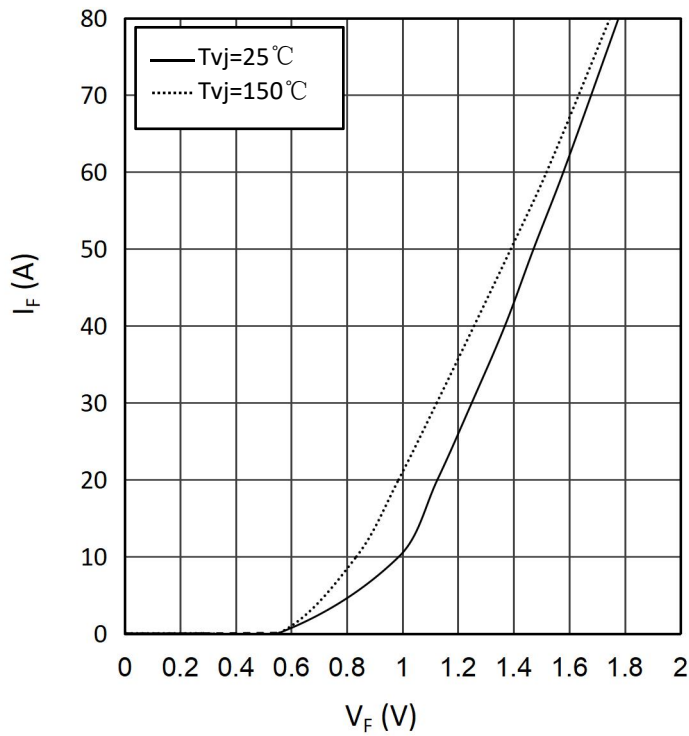
**NTC- Thermistor- temperature characteristic( typical)**

$R=f(T)$



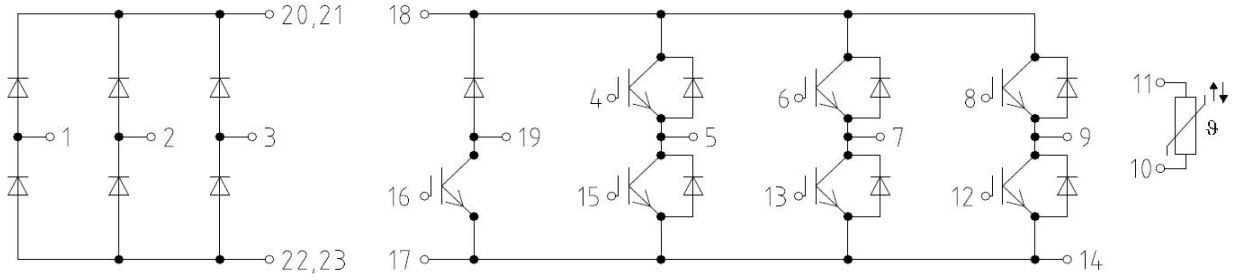
**Forward characteristic of Diode, Rectifier(typical)**

$I_F = f(V_F)$

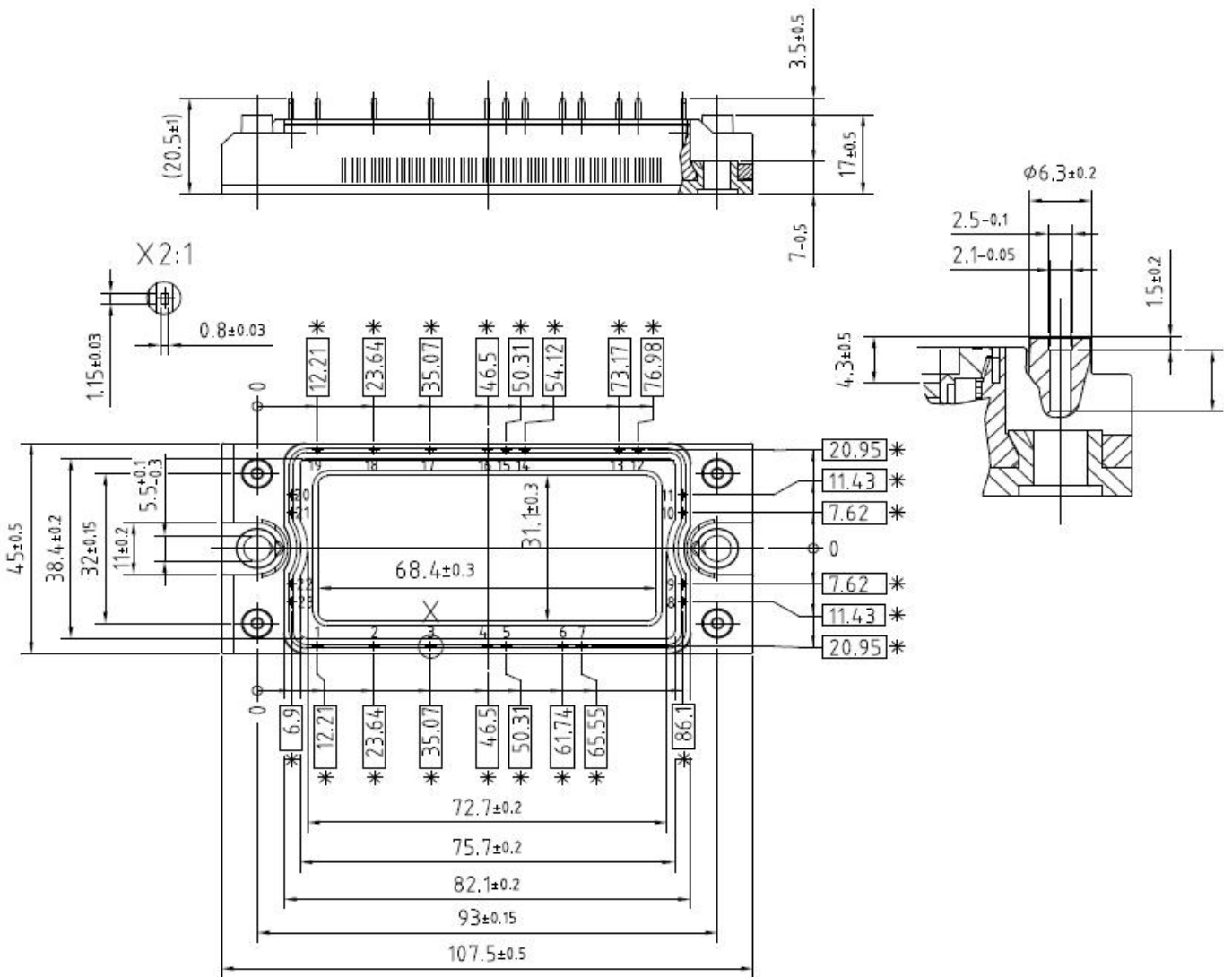




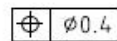
Circuit Diagram



Package Outlines



\* = alle Maße mit einer Toleranz von  
 \* = all dimensions with tolerance of



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